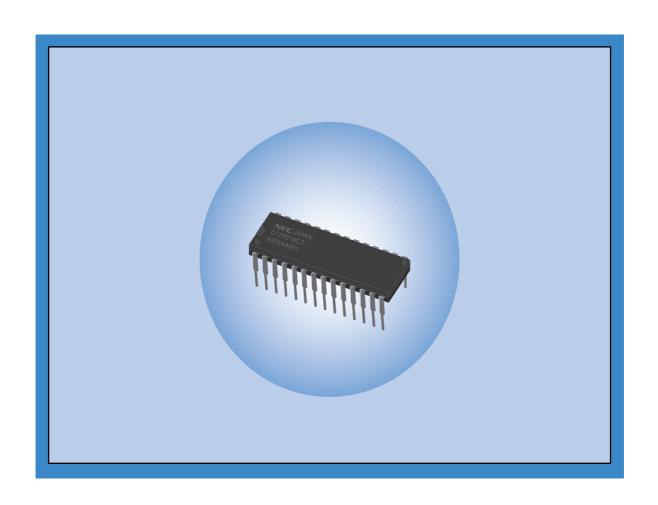


Microcontrollers for Remote Controllers



For General-Purpose Remote Controllers





fx = 3.5 to 4.5 MHz ceramic oscillation

μPD69A 4 KW/128

20 SSOP, 56 keys

High-speed instruction execution and low POC detection voltage selectable by mask option.

μPD68A 2 KW/32

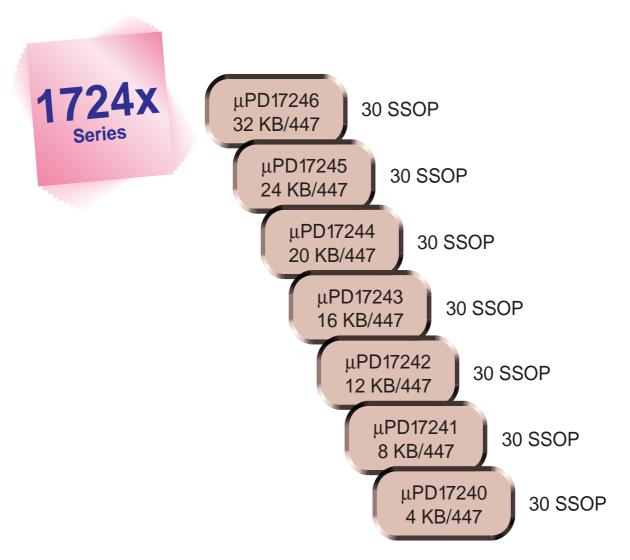
20 SSOP, 56 keys

μPD67A 1 KW/32

20 SSOP, 56 keys

For Preset Remote Controllers

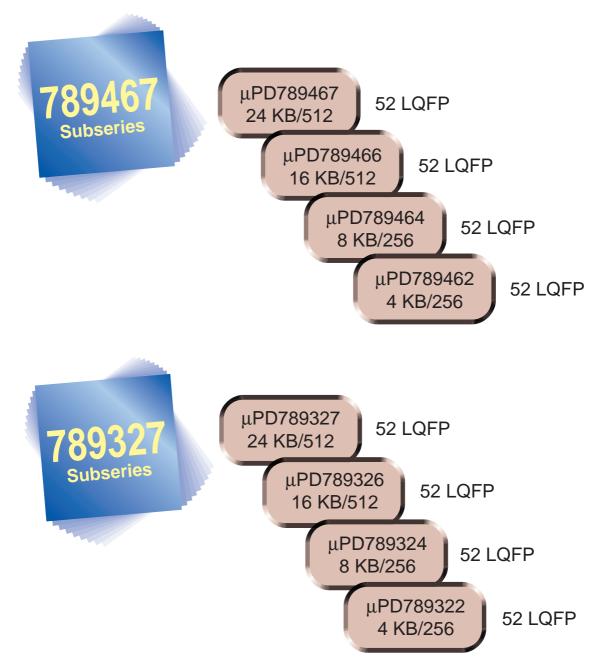






For LCD Remote Controllers





μPD69A Series



For infrared remote control transmitters/general-purpose applications

Part Number	μ ΡD67A	μ ΡD68A	μ ΡD69A	μ ΡD6P9		
Major applications	AV, household electric appliances					
ROM size	1002 × 10 bits 2026 × 10 bits 4074 × 10 bits					
		Mask ROM		One-time PROM		
RAM size	32 ×	32 × 4 bits 128 × 4 bits				
Number of supported keys	32 (standard)/56 (when using key expansion pin)					
Operation clock frequency (fx)	3.5 to 4.5 MHz (ceramic oscillation)					
Instruction execution time	16 μs (@ fx = 4 MHz) 16 μs or 8 μs ^{Note 1} (@ fx = 4 MHz)					
Modulation carrier frequency	Each high-/low-level width can be set from 250 ns to 64 μs (@ fx = 4 MHz) via modulo registers					
Timers		9-bit programmable timer: 1 channel, timer clock: fx/64				
POC circuit	On chip					
RAM retention detector	On chip					
Power supply voltage (VDD)	2.0 to	3.6 V	2.0 to 3.6 V or 1.8 to 3.6 V Note 2	2.2 to 3.6 V		
Package	20-pin plastic SSOP (7.62 mm (300))					
Development tools	Assembler					

Notes 1. Selectable by mask option in the μ PD69A. Fixed in each product of the μ PD6P9.

^{2.} Selectable by mask option

μPD1724x Series



For preset remote controllers/ small-scale general-purpose applications

Part Number	μ PD17240	μ PD17241	μ PD17242	μ PD17243	μ PD17244	μ PD17245	μ PD17246
Major applications	Preset remote controllers, toys, portable systems						
ROM size	2048 × 16 bits	4096 × 16 bits	6144 × 16 bits	8192 × 16 bits	10240 × 16 bits	12288 × 16 bits	16384 × 16 bits
RAM size	447 × 4 bits						
Carrier generator for infrared remote controller		On chip					
I/O ports		Input: 5, I/O: 19					
External interrupt		1					
Timers	2 channels						
Watchdog timer		On chip					
Low voltage detector		On chip					
RAM retention detector		On chip					
Instruction execution time (@ 4 MHz)	High-speed mode: 4 μs/Normal mode: 8 μs						
Power supply voltage (VDD)	2.0 to 3.6 V						
Package	30-pin plastic SSOP (7.62 mm (300))						
One-time PROM product	μPD17P246						
Development tools	Assembler, device file, integrated debugger, in-circuit emulator						





For preset remote controllers/ small-scale general-purpose applications

Part	Number	μ PD789086	μ PD789088	μ PD78F9088			
Major applications		Preset remote controllers, toys, portable systems					
ROM size		16 KB 32 KB					
		Mask	ROM	Flash memory			
RAI	ytes						
Operation clo	ck frequency (fx)	1	.0 to 5.0 MHz (ceramic/crystal oscillator)				
Instruction (execution time		$0.4 \mu s/0.8 \mu s/1.6 \mu s$ (@ fx = $5.0 MHz$)				
General-pu	rpose registers		8 bits × 8 registers				
Instru	ction set		16-bit operations				
			Bit manipulation (set, reset, test) etc.				
I/O	ports		24				
Ti	mers	8-bit timer: 3 channels					
		• 16-bit timer: 1 channel					
		Watchdog timer: 1 channel					
Timer	· outputs	1					
Serial	interface	UART/3-wire serial I/O mode: 1 channel					
Key return circuit		On chip					
Vectored	Maskable		Internal: 8, External: 2				
interrupt sources	Non- maskable	Internal: 1					
Reset			Reset by RESET signal input				
		Internal reset by watchdog timer					
		Reset via power-on-clear circuit					
Power supply voltage (VDD)		1.8 to 5.5 V					
Pa	ckage	30-pin plastic SSOP (7.62 mm (300))					
Develop	ment tools	Assembler, C compiler, device file, integrated debugger, system simulator, in-circuit emulator					

μPD789327 Subseries



For infrared remote control transmitters/LCD drive

Part	Number	μ PD789322	μ PD789324	μ PD789326	μ PD789327	μ PD78F9328		
Major a	pplications							
ROM size		4 KB	8 KB	16 KB	24 KB	32 KB		
			Mask	ROM		Flash memory		
RA	RAM size 256 bytes 512 bytes							
LCD displ	ay RAM size							
Opera	tion clock	• 1.0 to 5.0 MHz (Main system clock: Ceramic/crystal oscillation)						
frequ	ency (fx)		• 32.768 kHz (Subsyst	em clock: Crystal oscilla	ition)			
Instruction	execution time		• 0.4 μs/1.6 μs (@	5.0 MHz operation with	main system clock fx)			
			• 122 μs (@ 32.76	8 kHz operation with sub	osystem clock fxT)			
General-pu	rpose registers			8 bits × 8 registers				
Instru	ction set			operations				
			• Bit ma	anipulation (set, reset, te	est) etc.			
I/O	ports			21				
Ti	mers	• 8-bit timer: 2 channels						
		Watch timer: 1 channel						
		Watchdog timer: 1 channel						
	er output	1 Mask option On chip						
	Circuit		On chip					
	interface	3-wire serial I/O mode: 1 channel						
LCD con	troller/driver	Segment signal outputs: 24						
		Common signal outputs: 4						
Vectored	Maskable			Internal: 6, External: 2				
interrupt	Non-	Internal: 1						
sources maskable								
Reset		Reset by RESET signal input						
		Internal reset by watchdog timer Reset via power-on-clear circuit						
Power supply voltage (VDD)		1.8 to 5.5 V						
		2.00.00						
	ckage	A 1 1	52-pin plastic LQFP (10 × 10) Assembler, C compiler, device file, integrated debugger, system simulator, in-circuit emulator					
Develop	ment tools	Assembler	, C compiler, device file	, integrated debugger, s	system simulator, in-circu	uit emulator		

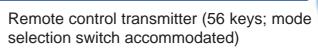




For infrared remote control transmitters/LCD drive

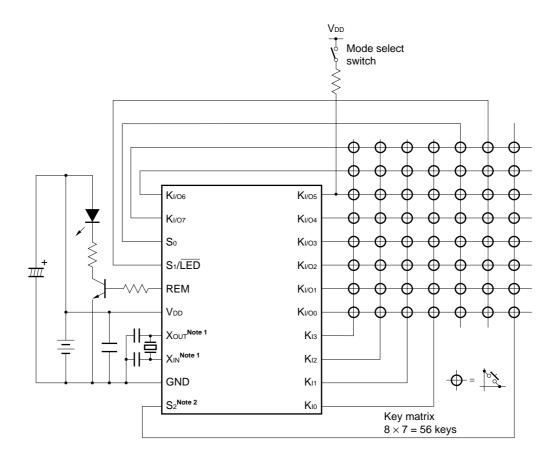
Part	Number	μ PD789462	μ PD789464	μ PD789466	μ PD789467	μ PD78F9468		
Major a	pplications	AV, air conditioners						
ROM size		4 KB	8 KB	16 KB	24 KB	32 KB		
			Mask ROM					
RA	M size	256 I	256 bytes 512 bytes					
LCD displ	ay RAM size	23 × 4 bits						
Opera	tion clock	• 1.0 to 5.0 MHz (Main system clock: Ceramic/crystal oscillation)						
frequ	ency (fx)		• 32.768 kHz (Subsyste	em clock: Crystal oscilla	tion)			
Instruction	execution time		• 0.4 µs/1.6 µs (@	5.0 MHz operation with	main system clock fx)			
			• 122 μs (@ 32.768	3 kHz operation with sub	system clock fxT)			
General-pu	rpose registers			8 bits × 8 registers				
Instru	ction set		• 16-bit	operations				
		Bit manipulation (set, reset, test) etc.						
I/O	ports			18				
Ti	mers	• 8-bit timer: 2 channels						
		Watch timer: 1 channel						
		Watchdog timer: 1 channel						
Time	r output	Mask option On chip						
POC	circuit		Mask option					
A/D c	onverter	8-bit resolution × 1 channel						
LCD controller/driver		Segment signal outputs: 23						
		Common signal outputs: 4						
		On-chip booster						
Vectored	Maskable		Internal: 6, External: 2					
interrupt	Non-	Internal: 1						
sources	maskable							
Reset		• Reset by RESET signal input						
		• Internal reset by watchdog timer						
		Reset via power-on-clear circuit						
Power supply voltage (VDD)		1.8 to 5.5 V						
Pa	ckage	52-pin plastic LQFP (10 × 10)						
Develop	ment tools	Assembler	, C compiler, device file	, integrated debugger, s	ystem simulator, in-circu	uit emulator		

Application





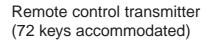
μPD69A Series



Notes 1. When incorporation of a capacitor for oscillation has not been specified by a mask option.

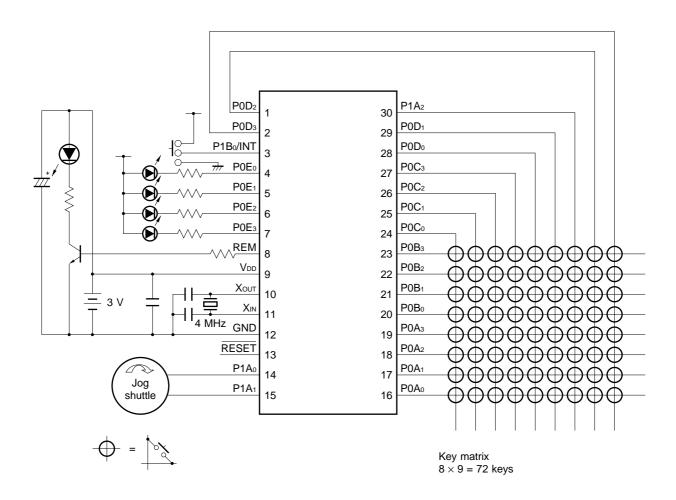
2. S2: Set to high level for STOP mode release

Application





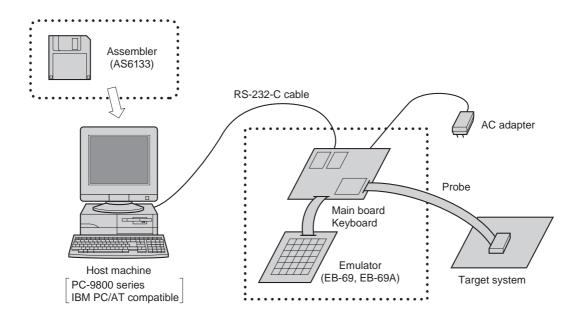
μPD1724x Series





The μPD69A Series is developed in the following environment.

Development environment: PC-9800 series, IBM PC/ATTM compatibles



Remarks 1. RS-232-C cable, probe, and AC adapter are sold separately.
 2. EB-69 and EB-69A (under development) are manufactured by Naito Densei Machida Mfg. Co., Ltd.



Features

- · Absolute assembler for µPD69A series.
- · Output load module file to serve as EB-69 and EB-69A input and diagnostic lists.



Features

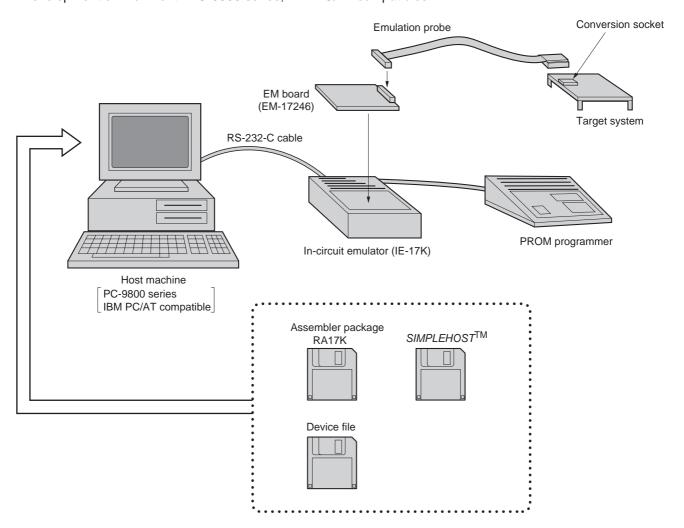
- Operations such as key input and infrared LED light emission confirmation can be performed using the keyboard unit provided.
- · Connection to target is possible using the probe (sold separately).
- *Event functions including step execution and program execution break are included.
- · Guard functions including stack overflow and coverage break are included.

Remark EB-69 and EB-69A (under development) are manufactured by Naito Densei Machida Mfg. Co., Ltd.



The μPD1724x Series is developed in the following environment.

Development environment: PC-9800 series, IBM PC/AT compatibles



Software

- · RA17K (relocatable assembler package)
- · Device file: Available for each product
- · SIMPLEHOST: Compatible with RA17K

Hardware

- IE-17K or IE-17K- ET (in-circuit emulator)
- EM-17246 (EM board manufactured by Naito Densei Machida Mfg. Co., Ltd.)
- · Emulation probe
- Conversion socket
- · PC-9800 series or IBM PC/AT compatible
- PROM programmer (for writing to one-time PROM such as AF-9706, AF-9708, AF-9709 manufactured by Ando Electric Co., Ltd.)
- · Programmer adapter (PA-17P236 manufactured by NEC)

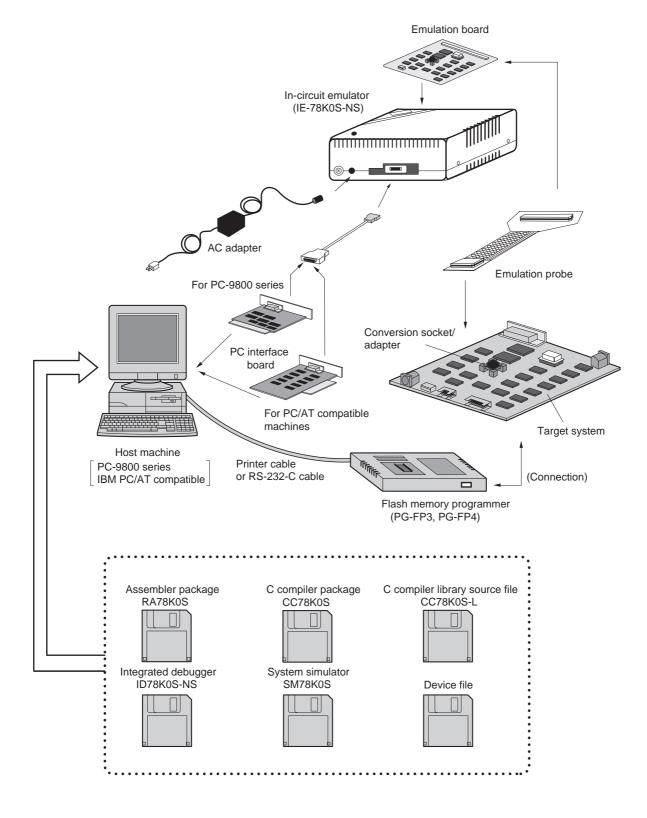
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The μ PD789088 subseries, 789327 subseries, and 789467 subseries are developed in the following environment.

Development environment: PC-9800 series, IBM PC/AT compatibles





μPD789088 subseries, 789327 subseries, and 789467 subseries

Software

- · RA78K0S (relocatable assembler package)
- · CC78K0S (C compiler package)
- · CC78K0S-L (C compiler library source file)
- · ID78K0S-NS (integrated debugger)
- · SM78K0S (system simulator)
- · Device file: Available for each product

Hardware

- · IE-78K0S-NS (in-circuit emulator)
- · IE-70000-MC-PS-B (AC adapter)
- · IE-70000-98-IF-C/IE-70000-PC-IF-C/IE-70000-PCI-IF-A/IE-70000-CD-IF-A (PC interface board)
- · Emulation board: Available for each product
- · Emulation probe
- · Conversion socket/adapter
- · PC-9800 series or IBM PC/AT compatible
- · Flash memory adapter (PG-FP3/PG-FP4, FL-PR3/FL-PR4 manufactured by Naito Densei Machida Mfg. Co., Ltd.)
- · Adapter for writing to flash memory (manufactured by Naito Densei Machida Mfg. Co., Ltd.)

Pamphlet U14372EJ4V0PF

Homepage



Please feel free to visit our Microprocessor home page for more information.

http://www.necel.com/micro/index_e.html

Memo



Memo



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